# SPIDER - TLE7232GS

SPI Driver for Enhanced Relay Control

**Automotive Power** 







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# SPI Driver for Enhanced Relay Control Eight Channel Low-Side Switch

# SPIDER - TLE7232GS

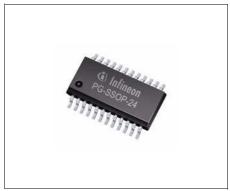




# 1 Product Summary

#### **Features**

- 16 bit SPI for diagnostics and control
- · SPI providing daisy chain capability
- 3.3 V and 5 V compatible SPI
- 3 input pins offers complete flexibility for PWM operation
- · Stable behavior at undervoltage
- Green Product (RoHS compliant)
- AEC Qualified



PG-SSOP-24-6

## Table 1 Product Summary

| Supply voltage                                | $V_{DD}$                            | 4.5 5.5 V |
|---|-------------------------------------|-----------|
| Supply voltage for SO buffer                  | $V_{\sf VSO}$                       | 3.0 5.5 V |
| On-State Resistance at 150 °C                 | R <sub>DS(ON, max)</sub>            | 2.1 Ω     |
| Nominal load current                          | $I_{L(nom,\;min)}$                  | 240 mA    |
| Overload current limitation                   | $I_{\mathrm{DS}(\mathrm{LIM,min})}$ | 1 A       |
| Power supply reset current (quiscent current) | $I_{\mathrm{DD(RST,max)}}$          | 5 μΑ      |
| Output leakage current per channel at 25 °C   | $I_{\mathrm{DS}(\mathrm{OFF,max})}$ | 1 μΑ      |
| Drain to source clamping voltage              | $V_{DS(CL,\;min)}$                  | 48 V      |
| SPI clock frequency                           | $f_{ m SCLK(max)}$                  | 5 MHz     |

| Туре               | Package      | Marking   |
|--------------------|--------------|-----------|
| SPIDER - TLE7232GS | PG-SSOP-24-6 | TLE7232GS |



**Product Summary** 

#### **Protective Functions**

- Short circuit protection
- Overload protection, configurable behavior (limitation or shutdown)
- Thermal shutdown, configurable behavior (latch or restart)
- Electrostatic discharge protection (ESD)

#### **Diagnostic Functions**

- · Diagnostic information via SPI
- Open load detection in OFF-state
- Shorted to GND detection in OFF-state
- Overtemperature in ON-state
- Overload in ON-state

#### **Applications**

- · Especially designed for driving relays in automotive applications
- · All types of capacitive, resistive and inductive loads

#### **Description**

The SPIDER - TLE7232GS is an eight channel low-side relay switch (typ.  $1.0~\Omega$  per channel) in PG-SSOP-24-6 package providing embedded protective functions. The 16 bit serial peripheral interface (SPI) is utilized for control and diagnosis of the device and the loads. The SPI interface provides daisy-chain capability in order to assemble multiple devices in one SPI chain by using the same number of micro-controller pins.

The SPIDER - TLE7232GS is equipped with three input pins that can be individually routed to the output control of some channels (please refer to **Section 5.1.2** for details) thus offering complete flexibility in design and PCB-layout. The input mapping as well as the boolean operation between input signal an output control signal is configured via SPI.

The device provides full diagnosis of the load, which is open load, short to GND as well as short circuit to  $V_{\rm bat}$  detection and overload / overtemperature indication. The SPI diagnosis flags indicate latched fault conditions that may have occurred.

Each output stage is protected against short circuit. In case of overload, the current of the affected channel is limited. There is a temperature sensor available for each channel to protect the device in case of overtemperature. The shut down behavior in case of overload or overtemperature can be configured via SPI for each channel individually.

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**Block Diagram** 

# 2 Block Diagram

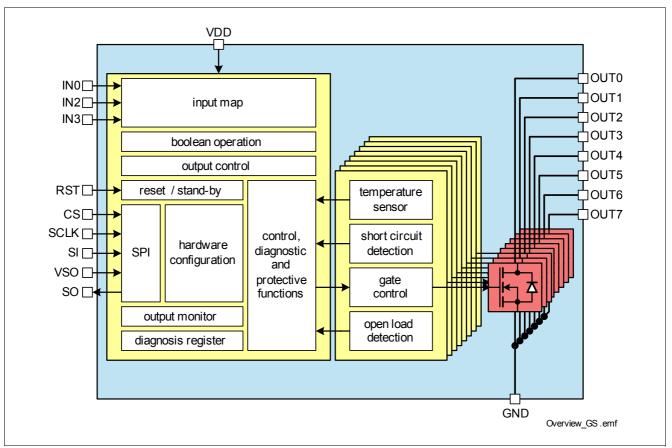


Figure 1 Block Diagram

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**Block Diagram** 

## 2.1 Terms

Following figure shows all terms used in this data sheet.

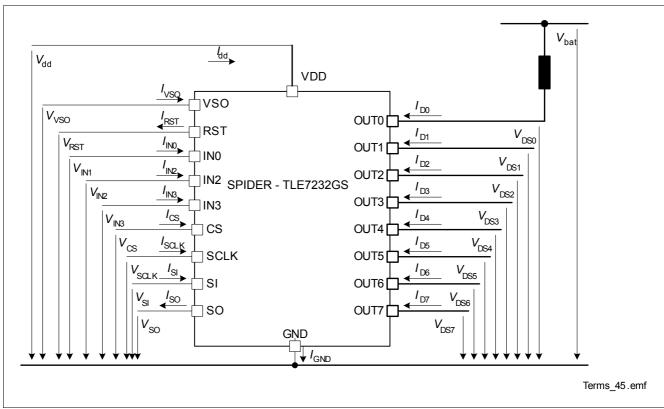


Figure 2 Terms

In all tables of electrical characteristics is valid: Channel related symbols without channel number are valid for each channel separately (e.g.  $V_{DS}$  specification is valid for  $V_{DS0}$  ...  $V_{DS7}$ ).

All SPI register bits are marked as follows: ADDR.PARAMETER (e.g. CTL.OUT0). In SPI register description, the values in bold letters (e.g. 0) are default values.

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**Pin Configuration** 

# 3 Pin Configuration

# 3.1 Pin Assignment

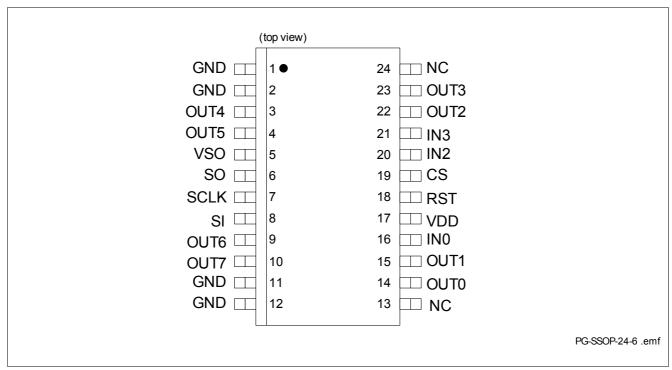


Figure 3 Pin Configuration

## 3.2 Pin Definitions and Functions

| Pin      | Symbol   | I/O                            | Function                                   |  |  |  |  |
|----------|----------|--------------------------------|--|--|--|--|--|
| Power    | Supply   |                                |  |  |  |  |  |
| 17       | $V_{DD}$ | V <sub>DD</sub> – Power Supply |  |  |  |  |  |
| 5        | $V_{SO}$ | _                              | Power Supply for SO buffer                 |  |  |  |  |
| 1, 2, 11 | , GND    | _                              | Ground                                     |  |  |  |  |
| 12       |          |                                |  |  |  |  |  |
| Power    | Stages   |                                |  |  |  |  |  |
| 14       | OUT0     | 0                              | <b>Drain</b> of power transistor channel 0 |  |  |  |  |
| 15       | OUT1     | 0                              | Drain of power transistor channel 1        |  |  |  |  |
| 22       | OUT2     | 0                              | Drain of power transistor channel 2        |  |  |  |  |
| 23       | OUT3     | О                              | Drain of power transistor channel 3        |  |  |  |  |
| 3        | OUT4     | О                              | Drain of power transistor channel 4        |  |  |  |  |
| 4        | OUT5     | О                              | <b>Drain</b> of power transistor channel 5 |  |  |  |  |
| 9        | OUT6     | 0                              | Drain of power transistor channel 6        |  |  |  |  |
| 10       | OUT7     | 0                              | Drain of power transistor channel 7        |  |  |  |  |

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# **Pin Configuration**

| Pin    | Symbol | I/O                                   | Function   |
|--------|--------|---------------------------------------|--|
| Inputs |        | ,                                     |  |
| 18     | RST    | I                                     | Reset Input Pin (active low)                     |
| 16     | IN0    | I                                     | Input Multiplexer Input Pin for output Out0      |
| 20     | IN2    | I                                     | Input Multiplexer Input Pin for output Out2      |
| 21     | IN3    | I                                     | Mappable Input Pin for all outputs, default Out3 |
| SPI    |        | ,                                     |  |
| 19     | CS     | I                                     | SPI Chip Select (active low)                     |
| 7      | SCLK   | I                                     | Serial Clock                                     |
| 8      | SI     | I                                     | Serial Data In                                   |
| 6      | SO     | 0                                     | Serial Data Out                                  |
| Not Us | ed     | · · · · · · · · · · · · · · · · · · · |  |
| 13, 24 | NC     | _                                     | Not connected                                    |



**General Product Characteristics** 

# 4 General Product Characteristics

# 4.1 Absolute Maximum Ratings

# Absolute Maximum Ratings 1)

 $T_{\rm j}$  = -40 °C to 150 °C;  $V_{\rm DD}$  = 4.5 V to 5.5 V; all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

| Pos.    | Parameter  | Symbol             | Lin          | nit Values         | Unit | Conditions   |  |
|---------|--|--------------------|--------------|--------------------|------|--|--|
|         |  |                    | Min.         | Max.               |      |  |  |
| Power S | Supply   |                    | <del>'</del> | 1                  |      | <u>'</u>   |  |
| 4.1.1   | Power supply voltage                                     | $V_{DD}$           | -0.3         | 5.5                | V    | _  |  |
| 4.1.2   | $V_{ m SO}$ supply voltage                               | $V_{\sf VSO}$      | -0.3         | $V_{\rm DD}$ + 0.3 | V    | 2)   |  |
| 4.1.3   | Power supply voltage for full short circuit              | $V_{\rm bat(SC)}$  | 0            | 20                 | V    | OAT = $0_3$  |  |
|         | protection (single pulse)                                | , ,                | _            | 28                 |      | OVL = 1  |  |
| Power S | Stages   |                    | ·            |                    |      |  |  |
| 4.1.4   | Load current   | $I_{D}$            | -1           | 1                  | Α    | _  |  |
| 4.1.5   | Voltage at power transistor                              | $V_{DS}$           | _            | 48                 | V    | _  |  |
| 4.1.6   | Maximum energy dissipation one                           | $E_{AS}$           |              |                    | mJ   | 4)   |  |
|         | channel single pulse                                     |                    | _            | 65                 |      | $T_{\rm j(0)}$ = 85 °C $I_{\rm D(0)}$ = 0.35 A     |  |
|         |  |                    | -            | 30                 |      | $T_{\rm j(0)}$ = 150 °C<br>$I_{\rm D(0)}$ = 0.25 A |  |
|         | Maximum energy dissipation one channel repetitive pulses | $E_{AR}$           |              |                    | mJ   | 4) $T_{i(0)} = 150  ^{\circ}\text{C}$              |  |
|         | 1 · 10 <sup>4</sup> cycles                               |                    | _            | 18                 |      | $I_{D(0)} = 0.20 \text{ A}$                        |  |
|         | 1 · 10 <sup>6</sup> cycles                               |                    | _            | 13                 |      | $I_{D(0)} = 0.17 \text{ A}$                        |  |
| Logic P | ins  | 1                  |              |                    |      |  |  |
| 4.1.7   | Voltage at input pins                                    | $V_{IN}$           | -0.3         | 5.5                | V    | _  |  |
| 4.1.8   | Voltage at reset pin                                     | $V_{RST}$          | -0.3         | 5.5                | V    | _  |  |
| 4.1.9   | Voltage at chip select pin                               | $V_{CS}$           | -0.3         | 5.5                | V    | _  |  |
| 4.1.10  | Voltage at serial clock pin                              | $V_{SCLK}$         | -0.3         | 5.5                | V    | _  |  |
| 4.1.11  | Voltage at serial input pin                              | $V_{\rm SI}$       | -0.3         | 5.5                | V    | _  |  |
| 4.1.12  | Voltage at serial output pin                             | $V_{SO}$           | -0.3         | 5.5                | V    | _  |  |
| Temper  | atures   | 1                  |              |                    | 1    |  |  |
| 4.1.13  | Junction Temperature                                     | $T_{i}$            | -40          | 150                | °C   | _  |  |
| 4.1.14  | Dynamic temperature increase while switching             | $\Delta T_{\rm j}$ | -            | 60                 | °C   | _  |  |
| 4.1.15  | Storage Temperature                                      | $T_{stg}$          | -55          | 150                | °C   | _  |  |
|         | ,  | o ig               |              | 1                  | 1    | 1  |  |

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#### **General Product Characteristics**

## Absolute Maximum Ratings (cont'd)1)

 $T_{\rm j}$  = -40 °C to 150 °C;  $V_{\rm DD}$  = 4.5 V to 5.5 V; all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

| Pos.   | Parameter                             | Symbol    | Limit Values |      | Unit     | Conditions        |  |
|--------|---------------------------------------|-----------|--------------|------|----------|-------------------|--|
|        |                                       |           | Min.         | Max. |          |                   |  |
| ESD Su | sceptibility                          |           |              |      | <u>'</u> |                   |  |
| 4.1.16 | ESD capability of all pins versus GND | $V_{ESD}$ | -2           | 2    | kV       | HBM <sup>5)</sup> |  |

<sup>1)</sup> Not subject to production test, specified by design.

- 2)  $V_{DD} + 0.3 \text{ V} < 5.5 \text{ V}$
- 3) Details on configuration of protective function OLCR.OVL can be found in Section 5.2.5
- 4) Pulse shape represents inductive switch off:  $I_D(t) = I_D(0) \times (1 t / t_{pulse})$ ;  $0 < t < t_{pulse}$
- 5) ESD susceptibility, HBM according to EIA/JESD 22-A114B

Note: Stresses above the ones listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note: Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.

#### 4.2 Thermal Resistance

Note: This thermal data was generated in accordance with JEDEC JESD51 standards. For more information, go to www.jedec.org.

| Pos.   | Parameter  | Symbol      | Limit Values |      |      | Unit | Conditions                     |  |
|--------|--|-------------|--------------|------|------|------|--------------------------------|--|
|        |  |             | Min.         | Тур. | Max. |      |                                |  |
| 4.2.17 | Junction to Solder Point                         | $R_{thJSP}$ | _            | _    | 25   | K/W  | pin 1, 2, 11, 12 <sup>1)</sup> |  |
| 4.2.18 | Junction to Ambient (1s0p+600mm <sup>2</sup> Cu) | $R_{thJA}$  | _            | 64   | _    | K/W  | 1)2)                           |  |
| 4.2.19 | Junction to Ambient (2s2p)                       | $R_{th,IA}$ | _            | 55   | _    | K/W  | 1)3)                           |  |

<sup>1)</sup> Specified  $R_{\text{thJSP}}$  value is simulated at natural convection on a cold plate setup (all pins are fixed to ambient temperature).  $T_{\text{a}} = 25 \,^{\circ}\text{C}$ . LS0 to LS7 are dissipating 1 W power (0.125 W each).

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<sup>2)</sup> Specified  $R_{\rm thJA}$  value is according to Jedec JESD51-2,-3 at natural convection on FR4 1s0p board; The product (Chip+Package) was simulated on a 76.2 x 114.3 x 1.5 mm board with additional heatspreading copper area of 600mm<sup>2</sup> and 70  $\mu$ m thickness.  $T_{\rm a}$  = 25 °C, LS0 to LS7 are dissipating 1 W power (0.125 W each).

<sup>3)</sup> Specified  $R_{\text{thJA}}$  value is according to Jedec JESD51-2,-7 at natural convection on FR4 2s2p board; The product (Chip+Package) was simulated on a 76.2 x 114.3 x 1.5 mm board with 2 inner copper layers (2 x 70  $\mu$ m Cu, 2 x 35  $\mu$ m Cu).  $T_a$  = 25 °C, LS0 to LS7 are dissipating 1 W power (0.125 W each).



**Block Description and Electrical Characteristics** 

# 5 Block Description and Electrical Characteristics

## 5.1 Power Stages

The SPIDER - TLE7232GS is an eight channel low-side relay switch. The power stages are built by N-channel vertical power MOSFET transistors.

#### 5.1.1 Power Supply

The SPIDER - TLE7232GS is supplied by power supply line  $V_{\rm DD}$  which is used for the digital as well as the analog functions of the device including the gate control of the power stages. There is a power-on reset function implemented for the supply line. After start-up of the power supply, all SPI registers are reset to their default values. A capacitor at pins  $V_{\rm DD}$  to GND is recommended.

The pin  $V_{\rm SO}$  is the supply pin of the digital output buffer at pin SO.

 $V_{\rm SO}$  can therefore be used to vary the high state output voltage of the SO pin, in order to be compatible to 3.3 V and 5 V microcontrollers. If  $V_{\rm SO}$  supply voltage is missing the device is fully functional, only the SO pin has no output.

There is a reset pin available. At low level at this pin, all registers are set to their default values and the quiescent supply current is minimized.

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# 5.1.2 Input Circuit

There are three input pins available at SPIDER - TLE7232GS to control the output stages.

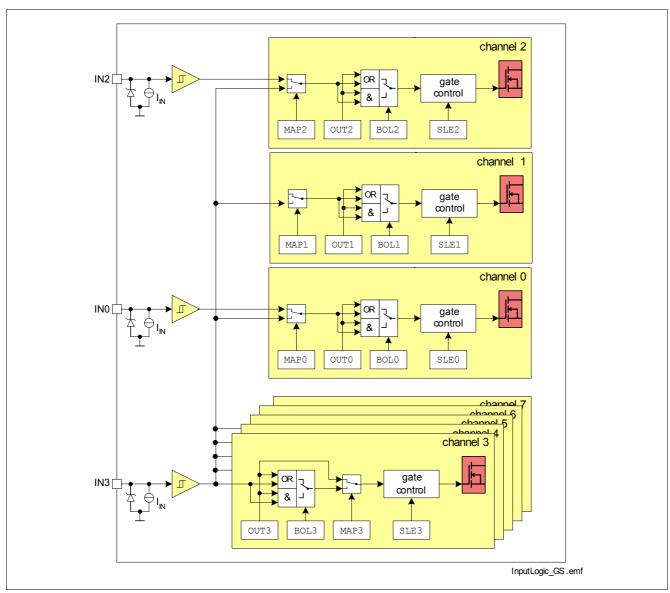


Figure 4 Input Mapping and Boolean Operator

The input signal of IN3 can be configured to be used as control signal of the output stages for each channel separately. The channels 0 to 2 differ from the channels 3 to 7 in the mapping behavior.

IN0 is a direct input to channel Out0, while IN2 is a direct input to Out2.

OUT0 can be switched with the SPI Flag MAP0 to the mappable input IN3, default is IN0.

OUT2 can be switched with the SPI Flag MAP2 to the mappable input IN3, default is IN2.

OUT3 is controlled by default with IN3, but IN3 can be programmed to each channel.

Therefore after power up the inputs are always mapped to their corresponding outputs.

Please refer to Figure 4 for details.

The current sink to ground at the input pins ensures that the channels switch off in case of open pin. The zener diode protects the input circuit against ESD pulses.

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## 5.1.3 Inductive Output Clamp

When switching off inductive loads, the potential at pin OUT rises to  $V_{\rm DS(CL)}$  potential, because the inductance intends to continue driving the current. The voltage clamping is necessary to prevent destruction of the device, see **Figure 5** for details. Nevertheless, the maximum allowed load inductance is limited.

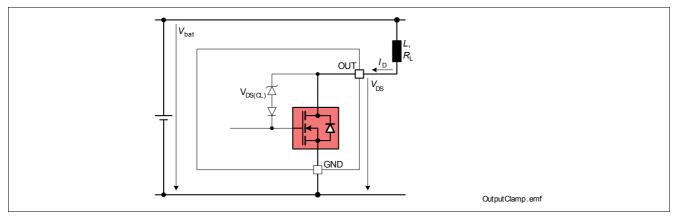


Figure 5 Output Clamp Implementation

#### **Maximum Load Inductance**

During demagnetization of inductive loads, energy has to be dissipated in the SPIDER - TLE7232GS. This energy can be calculated with following equation:

$$E = V_{\text{DS(CL)}} \cdot \left[ \frac{V_{\text{bat}} - V_{\text{DS(CL)}}}{R_{\text{L}}} \cdot \ln \left( 1 - \frac{R_{\text{L}} \cdot I_{\text{D}}}{V_{\text{bat}} - V_{\text{DS(CL)}}} \right) + I_{\text{D}} \right] \cdot \frac{L}{R_{\text{L}}}$$
(1)

The equation simplifies under the assumption of  $R_L$  = 0:

$$E = \frac{1}{2}LI_{D}^{2} \cdot \left(1 - \frac{V_{\text{bat}}}{V_{\text{bat}} - V_{\text{DS(CL)}}}\right)$$
 (2)

The energy, which is converted into heat, is limited by the thermal design of the component.

#### 5.1.4 Timing Diagrams

The power transistors are switched on and off with a dedicated slope via the OUT bits of the serial peripheral interface SPI. The switching times  $t_{ON}$  and  $t_{OFF}$  are designed equally.

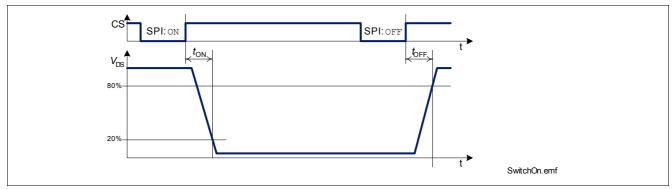


Figure 6 Switching a Resistive Load

When the input mapping is configured accordingly, a high signal at the input pin is equivalent to a SPI ON command.

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## 5.1.5 Electrical Characteristics

#### **Electrical Characteristics: Power Stages**

 $T_{\rm j}$  = -40 °C to 150 °C;  $V_{\rm DD}$  = 4.5 V to 5.5 V (unless otherwise specified); all voltages with respect to ground, positive current flowing into pin; typical values:  $V_{\rm DD}$  = 5.0 V,  $T_{\rm j}$  = 25 °C

| Pos.     | Parameter   | <b>Symbol</b>         |             | Limit Val | Unit        | Conditions |   |
|----------|---|-----------------------|-------------|-----------|-------------|------------|---|
|          |   |                       | Min. Typ.   |           | Max.        |            |   |
| Power S  | Supply  |                       |             |           |             | -          |   |
| 5.1.1    | Power supply voltage                                  | $V_{DD}$              | 4.5         | _         | 5.5         | V          | _   |
| 5.1.2    | Power supply current                                  | $I_{\rm DD(ON)}$      | _           | 3         | 5           | mA         | all channels ON   |
| 5.1.3    | Power supply reset current                            | $I_{\rm DD(RST)}$     | -           | -         | 5           | μА         | $\begin{aligned} V_{\text{RST}} &= 0 \text{ V} \\ V_{\text{IN}} &= 0 \text{ V} \\ V_{\text{SCLK}} &= 0 \text{ V} \\ V_{\text{SI}} &= 0 \text{ V} \\ V_{\text{CS}} &= V_{\text{DD}} \end{aligned}$ |
| 5.1.4    | Power-on reset threshold voltage                      | $V_{\rm DD(PO)}$      | _           | _         | 4.5         | V          | _   |
| Output   | Characteristics                                       |                       | ·           | ·         |             | ·          |   |
| 5.1.5    | On-State resistance per channel                       | $R_{DS(ON)}$          | -           | 1.0       | 1.2<br>2.1  | Ω          | $T_{\rm j}$ = 25 °C <sup>1)</sup><br>$T_{\rm j}$ = 150 °C<br>$I_{\rm L}$ = 500 mA<br>$V_{\rm DD}$ = 5 V   |
| 5.1.6    | Nominal load current                                  | $I_{L(nom)}$          | 240         | _         | _           | mA         | all channels ON based on $R_{\rm thJA}$ = 64 K/W $R_{\rm DS(ON)}$ = 2.1 $\Omega$ $T_{\rm A}$ = 85 °C $T_{\rm j,max}$ = 150 °C   |
| 5.1.7    | Output leakage current in stand-by mode (per channel) | $I_{D(RST)}$          | -<br>-<br>- |           | 1<br>2<br>5 | μΑ         | $V_{DS} = 13.5 \text{ V}$<br>$T_{j} = 25 \text{ °C}^{1)}$<br>$T_{j} = 125 \text{ °C}$<br>$T_{j} = 150 \text{ °C}^{1)}$  |
| 5.1.8    | Output clamping voltage                               | $V_{\mathrm{DS(CL)}}$ | 48          | _         | 60          | V          | _   |
| Input CI | haracteristics  |                       |             |           |             | -          |   |
| 5.1.9    | L level of pin IN                                     | $V_{IN(L)}$           | 0           | _         | 1.0         | V          | _   |
| 5.1.10   | H level of pin IN                                     | $V_{IN(H)}$           | 2.0         | _         | $V_{DD}$    | V          | _   |
| 5.1.11   | Input voltage hysteresis at pin IN                    | $\Delta V_{IN}$       | _           | 0.1       | -           | V          | 1)  |
| 5.1.12   | L-input pull-down current through pin IN              | $I_{IN(L)}$           | 10          | -         | 100         | μА         | 1) V <sub>IN</sub> = 1 V  |
| 5.1.13   | H-input pull-down current through pin IN              | $I_{IN(H)}$           | 20          | 50        | 100         | μА         | <i>V</i> <sub>IN</sub> = 5 V  |

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#### **Block Description and Electrical Characteristics**

## **Electrical Characteristics: Power Stages** (cont'd)

 $T_{\rm j}$  = -40 °C to 150 °C;  $V_{\rm DD}$  = 4.5 V to 5.5 V (unless otherwise specified); all voltages with respect to ground, positive current flowing into pin; typical values:  $V_{\rm DD}$  = 5.0 V,  $T_{\rm j}$  = 25 °C

| Pos.    | Parameter                                      | Symbol                | Limit Values |                                       |          | Unit | Conditions   |  |
|---------|--|-----------------------|--------------|---------------------------------------|----------|------|--|--|
|         |  |                       | Min.         | Тур.                                  | Max.     |      |  |  |
| Reset   |  | -                     |              | , , , , , , , , , , , , , , , , , , , | "        |      |  |  |
| 5.1.14  | L level of pin RST                             | $V_{\mathrm{RST(L)}}$ | 0            | _                                     | 1        | V    | _  |  |
| 5.1.15  | H level of pin RST                             | $V_{RST(H)}$          | 2            | _                                     | $V_{DD}$ | V    | _  |  |
| 5.1.16  | L-input pull-up current through pin RST        | $I_{RST(L)}$          | 0            | _                                     | 10       | μА   | $V_{\rm RST}$ = 1 V  |  |
| 5.1.17  | H-input pull-up current through pin RST        | $I_{RST(H)}$          | 20           | 50                                    | 100      | μА   | $V_{RST}$ = 2 V  |  |
| Timings | 3  |                       | <u> </u>     |                                       |          |      |  |  |
| 5.1.18  | Power-on wake-up time                          | $t_{\text{wu(PO)}}$   | -            | _                                     | 200      | μS   | _  |  |
| 5.1.19  | Reset duration                                 | $t_{RST(L)}$          | 10           | _                                     | _        | μS   | _  |  |
| 5.1.20  | Turn-on time $V_{\rm DS}$ = 20% $V_{\rm bat}$  | t <sub>ON</sub>       |              |                                       |          | μS   | $V_{\rm bat}$ = 14 V $I_{\rm DS}$ = 500 mA, resistive load |  |
|         |  |                       | _            | _                                     | 15       |      | SLE = 0  |  |
|         |  |                       | _            | _                                     | 60       |      | SLE = 1  |  |
| 5.1.21  | Turn-off time $V_{\rm DS}$ = 80% $V_{\rm bat}$ | t <sub>OFF</sub>      |              |                                       |          | μS   | $V_{\rm bat}$ = 14 V $I_{\rm DS}$ = 500 mA, resistive load |  |
|         |  |                       | -            | _                                     | 15       |      | SLE = 0  |  |
|         |  |                       | -            | -                                     | 60       |      | SLE = 1  |  |

<sup>1)</sup> Not subject to production test, specified by design.

Note: Characteristics show the deviation of parameter at the given supply voltage and junction temperature.

Typical values show the typical parameters expected from manufacturing.

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## **Block Description and Electrical Characteristics**

Reset Value: 08<sub>H</sub>

Reset Value: 00<sub>H</sub>

Reset Value: 00<sub>H</sub>

# 5.1.6 Command Description

#### **IMCR**

| 7    | 6    | 5    | 4    | 3    | 2    | 1    | 0    |
|------|------|------|------|------|------|------|------|
| MAP7 | MAP6 | MAP5 | MAP4 | MAP3 | MAP2 | MAP1 | MAP0 |
| rw   |

| Field             | Bits | Type | Description  |
|-------------------|------|------|--|
| MAPn<br>(n = 7-0) | n    | rw   | Input Mapping Configuration Channel n  O Channel n can not be controlled with mappable input pin IN3.  OUT0 is controlled by IN0.  OUT2 is controlled by IN2.  OUT3 is controlled by the mappable IN3 (default value). |
|                   |      |      | 1 Channel n can be controlled with mapable input pin IN3, depending on additional set-up.  |

#### **BOCR**

## **Boolean Operator Configuration Register**

| 7    | 6    | 5    | 4    | 3    | 2    | 1    | 0    |
|------|------|------|------|------|------|------|------|
| BOL7 | BOL6 | BOL5 | BOL4 | BOL3 | BOL2 | BOL1 | BOL0 |
| rw   |

| Field     | Bits | Туре | Description  |  |  |  |  |  |
|-----------|------|------|--|--|--|--|--|--|
| BOLn      | n    | rw   | Boolean Operator Configuration Channel n   |  |  |  |  |  |
| (n = 7-0) |      |      | <ul><li>0 Logic "OR" for channel n (default value).</li><li>1 Logic "AND" for channel n.</li></ul> |  |  |  |  |  |

#### SRCR

## **Slew Rate Configuration Register**

| 7    | 6    | 5    | 4    | 3    | 2    | 1    | 0    |
|------|------|------|------|------|------|------|------|
| SLE7 | SLE6 | SLE5 | SLE4 | SLE3 | SLE2 | SLE1 | SLE0 |
| rw   |

| Field     | Bits | Type | Description                                   |  |  |  |
|-----------|------|------|---|--|--|--|
| SLEn      | n    | rw   | Slew Rate Configuration Channel n             |  |  |  |
| (n = 7-0) |      |      | O Channel n is switched fast (default value). |  |  |  |
|           |      |      | 1 Channel n is switched slowly.               |  |  |  |

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# CTL Output Control Register

| Reset Value: 0 | 0 <sub>H</sub> |
|----------------|----------------|
|----------------|----------------|

| 7    | 6    | 5    | 4    | 3    | 2    | 1    | 0    |
|------|------|------|------|------|------|------|------|
| OUT7 | ОИТ6 | OUT5 | OUT4 | ОПТЗ | OUT2 | OUT1 | ОПТО |
| rw   |

| Field     | Bits | Туре | Description   |
|-----------|------|------|---|
| OUTn      | n    | rw   | Output Control Channel n                                    |
| (n = 7-0) |      |      | 0 Channel n is switched off (default value).                |
|           |      |      | 1 Channel n is switched on, depending on additional set-up. |

#### 5.2 Protection Functions

The device provides embedded protective functions. Integrated protection functions are designed to prevent IC destruction under fault conditions described in this Data Sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.

There is an overload and overtemperature protection implemented in the SPIDER - TLE7232GS. The behavior of the protective functions can be set-up via SPI. Following figure gives an overview about the protective functions.

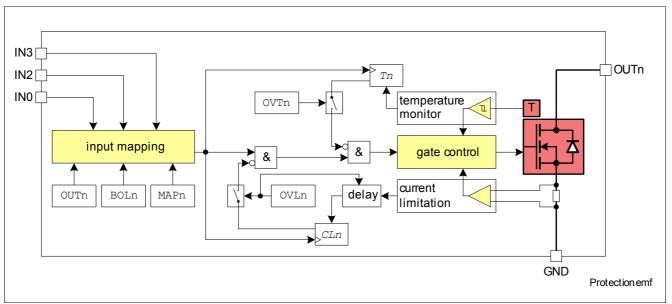


Figure 7 Protective Functions

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#### 5.2.1 Overload Protection

The SPIDER - TLE7232GS is protected in case of overload or short circuit of the load. The behavior in case of overload can be configured as follows:

- 1. The current is limited to  $I_{DS(LIM)}$ . After time  $t_{d(fault)}$ , the according overload flag CLn is set. The channel may shut down due to overtemperature.
- 2. The current is limited to  $I_{DS(LIM)}$ . After time  $t_{d(off)}$ , the overloaded channel n switches off and the according overload flag CLn is set.

The overload flag (CLn) of the affected channel is cleared by a low-high transition of the input signal. For timing information, please refer to **Figure 8** for details.

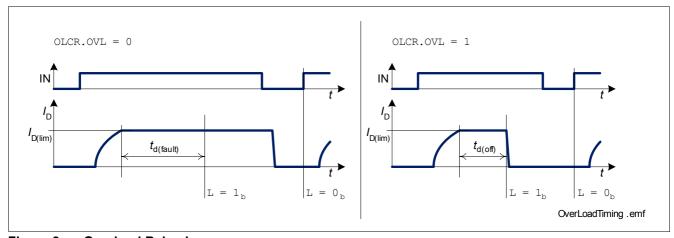


Figure 8 Overload Behavior

## 5.2.2 Overtemperature Protection

A temperature sensor for each channel causes an overheated channel n to switch off immediately to prevent destruction. The behavior in case of overtemperature can be configured as follows:

- 1. After cooling down, the channel is switched on again with thermal hysteresis  $\Delta T_i$ .
- 2. The affected channel stays switched off until the overtemperature flag is cleared.

The overtemperature flag of the affected channel is cleared by a low-high transition of the input signal.

#### 5.2.3 Reverse Polarity Protection

In case of reverse polarity, the intrinsic body diode of the power transistor causes power dissipation. The reverse current through the intrinsic body diode has to be limited by the connected load. The  $V_{\rm DD}$  supply pin must be protected against reverse polarity externally. The overtemperature protection as well as other protective functions are not active during reverse polarity.

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#### **Block Description and Electrical Characteristics**

Reset Value: 00<sub>H</sub>

Reset Value: 00<sub>H</sub>

#### 5.2.4 Electrical Characteristics

#### **Electrical Characteristics: Protection Functions**

 $V_{\rm DD}$  = 4.5 V to 5.5 V,  $T_{\rm j}$  = -40 °C to 150 °C, all voltages with respect to ground, positive current flowing into pin (unless otherwise specified); typical values:  $V_{\rm DD}$  = 5.0 V,  $T_{\rm j}$  = 25 °C

| Pos.   | Parameter                           | Symbol                 |      | Limit Val | ues  | Unit | Conditions |  |
|--------|-------------------------------------|------------------------|------|-----------|------|------|------------|--|
|        |                                     |                        | Min. | Тур.      | Max. |      |            |  |
| Overlo | ad Protection                       |                        |      |           |      |      |            |  |
| 5.2.1  | Overload current limitation         | $I_{D(lim)}$           | 1    | _         | 2    | Α    | OAT = 0    |  |
| 5.2.2  | Overload shut-down delay time       | $t_{\sf d(off)}$       | 10   | _         | 50   | μS   | OVL = 1    |  |
| Overte | mperature Protection                |                        |      |           |      |      |            |  |
| 5.2.3  | Overtemperature shut-down threshold | $T_{\rm j(OT)}$        | 170  | _         | 200  | °C   | 1)         |  |
| 5.2.4  | Thermal hysteresis                  | $\Delta T_{\rm j(OT)}$ | _    | 10        | _    | K    | 1)         |  |

<sup>1)</sup> Not subject to production test, specified by design.

# 5.2.5 Command Description

#### **OLCR**

### **Overload Configuration Register**

| 7    | 6    | 5    | 4    | 3    | 2    | 1    | 0    |
|------|------|------|------|------|------|------|------|
| OVL7 | OVL6 | OVL5 | OVL4 | OVL3 | OVL2 | OVL1 | OVL0 |
| rw   |

| Field     | Bits | Type | Description   |
|-----------|------|------|---|
| OVLn      | n    | rw   | Overload Configuration Channel n  |
| (n = 7-0) |      |      | <ul><li>Channel n limits the current in case of overload (default value).</li><li>Channel n shuts down in case of overload.</li></ul> |

#### **OTCR**

#### **Overtemperature Configuration Register**

| 7    | 6    | 5    | 4    | 3    | 2    | 1    | 0    |
|------|------|------|------|------|------|------|------|
| OVT7 | OVT6 | OVT5 | OVT4 | OVT3 | OVT2 | OVT1 | OVT0 |
| rw   |

| Field     | Bits | Type | Description                             |
|-----------|------|------|---|
| OVTn      | n    | rw   | Overtemperature Configuration Channel n |
| (n = 7-0) |      |      | 0 Autorestart (default value)           |
|           |      |      | 1 Latched shut down                     |

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# 5.3 Diagnostic Features

The SPI of SPIDER - TLE7232GS provides diagnosis information about the device and about the load. There are following diagnosis flags implemented:

- The diagnosis information of the protective functions (flags CLn and Tn) of channel n is latched in the diagnosis flag Pn.
- The open load diagnosis of channel n is latched in the diagnosis flag OLn.
- The short to GND monitor information of channel n is latched in the diagnosis flag SGn.

All flags are cleared after a successful SPI transmission.

There is an output state monitor implemented in the device that indicates the switch state of the device in register STA. Depending on the voltage level at input pin and protective functions the bits are high or low.

Please see Figure 9 for details:

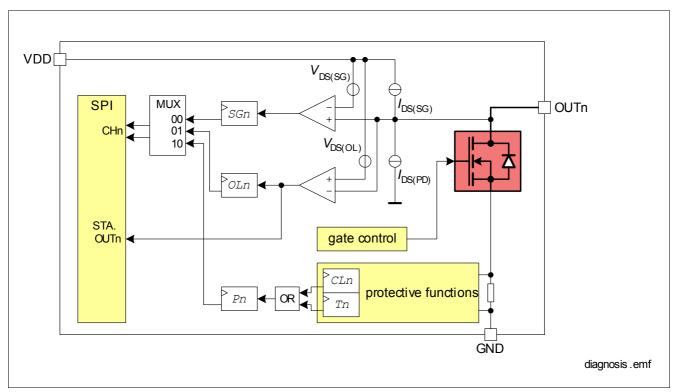


Figure 9 Block Diagram Diagnosis

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# 5.3.1 Diagnosis Timing

The SPIDER - TLE7232GS offers 2 different diagnosis for each channel in OFF mode.

## 5.3.1.1 Open Load Behavior

The device offers a open load diagnosis for each channel in OFF mode.

The time  $t_{d(fault)}$  is applied to filter short time events.

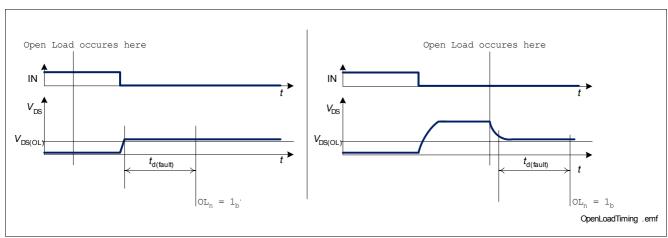


Figure 10 Open Load Timing

#### 5.3.1.2 Short to Ground Behavior

The device offers a short to ground detection for each channel in OFF mode.

The time  $t_{d(fault)}$  is applied to filter short time events.

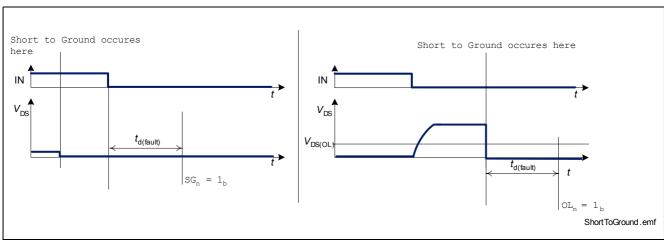


Figure 11 Short to Ground Timing

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#### **Block Description and Electrical Characteristics**

#### **5.3.2** Electrical Characteristics

#### **Electrical Characteristics: Diagnostic**

 $V_{\rm DD}$  = 4.5 V to 5.5 V,  $T_{\rm j}$  = -40 °C to 150 °C, all voltages with respect to ground, positive current flowing into pin (unless otherwise specified); typical values:  $V_{\rm DD}$  = 5.0 V,  $T_{\rm j}$  = 25 °C

| Pos.  | Parameter   | Symbol                | L                     | imit Value            | es                    | Unit | Conditions         |
|-------|---|-----------------------|-----------------------|-----------------------|-----------------------|------|--------------------|
|       |   |                       | Min.                  | Тур.                  | Max.                  |      |                    |
| OFF S | tate Diagnosis  | 1                     | 1                     |                       | 1                     |      |                    |
| 5.3.1 | Open load detection threshold voltage                 | $V_{\mathrm{DS(OL)}}$ | V <sub>DD</sub> - 2.5 | V <sub>DD</sub> - 2   | V <sub>DD</sub> - 1.3 | V    | _                  |
| 5.3.2 | Output pull-down diagnosis current per channel        | $I_{D(PD)}$           | 50                    | 90                    | 150                   | μΑ   | _                  |
| 5.3.3 | Short to GND detection threshold voltage              | $V_{\mathrm{DS(SG)}}$ | V <sub>DD</sub> - 3.4 | V <sub>DD</sub> - 3.0 | V <sub>DD</sub> - 2.6 | V    | _                  |
| 5.3.4 | Output diagnosis current for short to GND per channel | $I_{D(SG)}$           | -150                  | -100                  | -50                   | μΑ   | $V_{\rm DS}$ = 0 V |
| 5.3.5 | Fault delay time                                      | $t_{\rm d(fault)}$    | 50                    | 100                   | 200                   | μS   | _                  |

# 5.3.3 Command Description

# STA

Output Status Monitor Reset Value: 00<sub>H</sub>

| 7    | 6    | 5    | 4    | 3    | 2    | 1    | 0    |
|------|------|------|------|------|------|------|------|
| OUT7 | OUT6 | OUT5 | OUT4 | OUT3 | OUT2 | OUT1 | OUT0 |
| r    | r    | r    | r    | r    | r    | r    | r    |

| Field     | Bits | Туре | Description   |
|-----------|------|------|---|
| OUTn      | n    | r    | Output Status   |
| (n = 7-0) |      |      | 0 Voltage level at channel n: $V_{\rm DS}$ > $V_{\rm DS(OL)}$ . |
|           |      |      | 1 Voltage level at channel n: $V_{\rm DS}$ < $V_{\rm DS(OL)}$ . |

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#### **Block Description and Electrical Characteristics**

### 5.4 Serial Peripheral Interface (SPI)

The diagnosis and control interface is based on a serial peripheral interface (SPI).

The SPI is a full duplex synchronous serial slave interface, which uses four lines: SO, SI, SCLK and  $\overline{CS}$ . Data is transferred by the lines SI and SO at the data rate given by SCLK. The falling edge of  $\overline{CS}$  indicates the beginning of a data access. Data is sampled in on line SI at the falling edge of  $\overline{SCLK}$  and shifted out on line SO at the rising edge of SCLK. Each access must be terminated by a rising edge of  $\overline{CS}$ . A modulo 8 counter ensures that data is taken only, when a multiple of 8 bit has been transferred. The interface provides daisy chain capability.

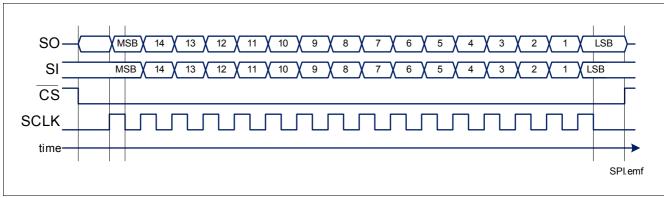


Figure 12 Serial Peripheral Interface

The SPI protocol is described in **Section 5.4.5**. It is reset to the default values after power-on reset or a low signal at pin RST.

## 5.4.1 SPI Signal Description

CS - Chip Select: The system microcontroller selects the SPIDER - TLE7232GS by means of the  $\overline{\text{CS}}$  pin. Whenever the pin is in low state, data transfer can take place. When  $\overline{\text{CS}}$  is in high state, any signals at the SCLK and SI pins are ignored and SO is forced into a high impedance state.

#### CS High to Low Transition: —

The diagnosis information is transferred into the shift register.

#### CS Low to High Transition:

- Command decoding is only done, when after the falling edge of  $\overline{CS}$  exactly a multiple (1, 2, 3, ...) of eight SCLK signals have been detected.
- Data from shift register is transferred into the input matrix register.
- The diagnosis flags are cleared.

**SCLK - Serial Clock**: This input pin clocks the internal shift register. The serial input (SI) transfers data into the shift register on the falling edge of SCLK while the serial output (SO) shifts diagnostic information out on the rising edge of the serial clock. It is essential that the SCLK pin is in low state whenever chip select  $\overline{CS}$  makes any transition.

**SI - Serial Input:** Serial input data bits are shifted in at this pin, the most significant bit first. SI information is read on the falling edge of SCLK. The 16 bit input data consist of two parts (control and data). Please refer to **Section 5.4.5** for further information.

**SO Serial Output:** Data is shifted out serially at this pin, the most significant bit first. SO is in high impedance state until the  $\overline{\text{CS}}$  pin goes to low state. New data will appear at the SO pin following the rising edge of SCLK. Please refer to **Section 5.4.5** for further information. The high state output voltage depends on the voltage at pin  $V_{\text{SO}}$ .

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## 5.4.2 Daisy Chain Capability

The SPI of SPIDER - TLE7232GS provides daisy chain capability. In this configuration several devices are activated by the same  $\overline{\text{CS}}$  signal  $\overline{\text{MCS}}$ . The SI line of one device is connected with the SO line of another device (see Figure 13), which builds a chain. The ends of the chain are connected with the output and input of the master device, MO and MI respectively. The master device provides the master clock MCLK, which is connected to the SCLK line of each device in the chain.

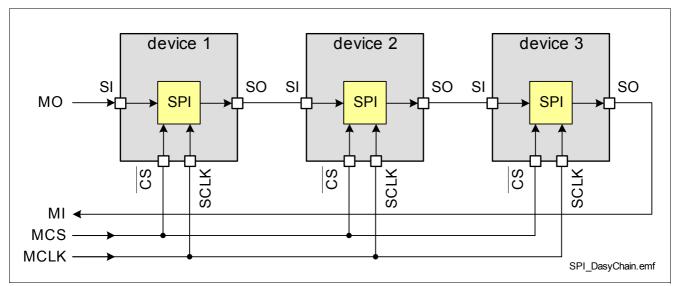


Figure 13 Daisy Chain Configuration

In the SPI block of each device, there is one shift register where one bit from SI line is shifted in each SCLK. The bit shifted out can be seen at SO. After 16 SCLK cycles, the data transfer for one device has been finished. In single chip configuration, the  $\overline{\text{CS}}$  line must go high to make the device accept the transferred data. In daisy chain configuration the data shifted out at device #1 has been shifted in to device #2. When using three devices in daisy chain, three times 16 bits have to be shifted through the devices. After that, the  $\overline{\text{MCS}}$  line must go high (see Figure 14).

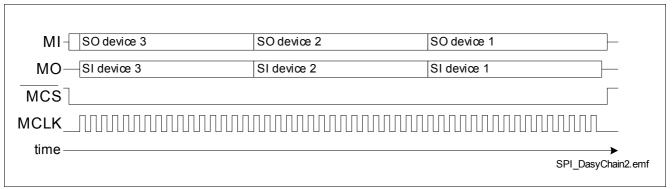


Figure 14 Data Transfer in Daisy Chain Configuration

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# 5.4.3 Timing Diagrams

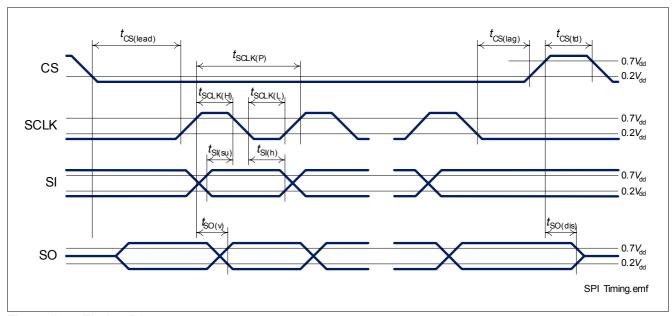


Figure 15 Timing Diagram

## 5.4.4 Electrical Characteristics

#### **Electrical Characteristics: SPI**

 $V_{\rm DD}$  = 4.5 V to 5.5 V,  $T_{\rm j}$  = -40 °C to 150 °C, all voltages with respect to ground, positive current flowing into pin (unless otherwise specified); typical values:  $V_{\rm DD}$  = 5.0 V,  $T_{\rm j}$  = 25 °C

| Pos.    | Parameter                          | Symbol                 | I    | Limit Val | ues      | Unit | Conditions                                   |  |
|---------|------------------------------------|------------------------|------|-----------|----------|------|--|--|
|         |                                    |                        | Min. | Min. Typ. |          |      |  |  |
| Power   | Supply                             | 1                      |      |           |          |      |  |  |
| 5.4.1   | Power supply voltage for SO buffer | $V_{\sf VSO}$          | 3.0  | _         | 5.5      | V    | _  |  |
| Input C | Characteristics (CS, SCLK, SI)     | 1                      | '    | "         | <u> </u> |      | <u>,                                    </u> |  |
| 5.4.2   | L level of pin                     |                        | 0    | _         | 1        | V    | _  |  |
|         | <del>CS</del>                      | $V_{\mathrm{CS(L)}}$   |      |           |          |      |  |  |
|         | SCLK                               | $V_{\rm SCLK(L)}$      |      |           |          |      |  |  |
|         | SI                                 | $V_{\rm SI(L)}$        |      |           |          |      |  |  |
| 5.4.3   | H level of pin                     |                        | 2    | _         | $V_{DD}$ | V    | _  |  |
|         | CS                                 | $V_{\mathrm{CS(H)}}$   |      |           |          |      |  |  |
|         | SCLK                               | $V_{\rm SCLK(H)}$      |      |           |          |      |  |  |
|         | SI                                 | $V_{\rm SI(H)}$        |      |           |          |      |  |  |
| 5.4.4   | L-input pull-up current through CS | $I_{\mathrm{CS(L)}}$   | 10   | 20        | 50       | μΑ   | $V_{\rm CS}$ = 0 V                           |  |
| 5.4.5   | H-input pull-up current through CS | $I_{\mathrm{CS(H)}}$   | 5    | _         | 50       | μΑ   | 1)   |  |
|         |                                    |                        |      |           |          |      | $V_{\rm CS}$ = 2 V                           |  |
| 5.4.6   | L-input pull-down current through  |                        |      |           |          | μΑ   | 1)   |  |
|         | pin                                |                        |      |           |          |      |  |  |
|         | SCLK                               | $I_{\mathrm{SCLK(L)}}$ | 5    | -         | 50       |      | $V_{\rm SCLK}$ = 1 V                         |  |
|         | SI                                 | $I_{\rm SI(L)}$        | 5    | _         | 50       |      | $V_{\rm SI}$ = 1 V                           |  |

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#### **Block Description and Electrical Characteristics**

## Electrical Characteristics: SPI (cont'd)

 $V_{\rm DD}$  = 4.5 V to 5.5 V,  $T_{\rm j}$  = -40 °C to 150 °C, all voltages with respect to ground, positive current flowing into pin (unless otherwise specified); typical values:  $V_{\rm DD}$  = 5.0 V,  $T_{\rm j}$  = 25 °C

| Pos.   | Parameter  | Symbol                  | I    | Limit Val | ues  | Unit | Conditions                |  |
|--------|--|-------------------------|------|-----------|------|------|---------------------------|--|
|        |  |                         | Min. | Typ.      | Max. |      |                           |  |
| 5.4.7  | H-input pull-down current through  |                         |      |           |      | μΑ   |                           |  |
|        | pin  |                         |      |           |      |      |                           |  |
|        | SCLK   | $I_{\rm SCLK(H)}$       | 10   | 20        | 50   |      | $V_{\rm SCLK}$ = 5 V      |  |
|        | SI   | $I_{SI(H)}$             | 10   | 20        | 50   |      | $V_{\rm SI}$ = 5 V        |  |
| Output | Characteristics (SO)   |                         |      |           |      |      | •                         |  |
| 5.4.8  | L level output voltage   | $V_{\rm SO(L)}$         | 0    | _         | 0.4  | V    | $I_{\rm SO}$ = -2.5 mA    |  |
| 5.4.9  | H level output voltage   | $V_{SO(H)}$             | _    | _         | _    | _    | $I_{SO}$ = 2 mA           |  |
|        |  | , ,                     | 4.6  | _         | 5    |      | $V_{\rm VSO}$ = 5 V       |  |
|        |  |                         | 2.4  | -         | 3    |      | $V_{\rm VSO}$ = 3 V       |  |
| 5.4.10 | Output tristate leakage current  | $I_{\rm SO(OFF)}$       | -10  | _         | 10   | μΑ   | $V_{\rm CS} = V_{\rm DD}$ |  |
| Timing | s  |                         |      |           |      |      | •                         |  |
| 5.4.11 | Serial clock frequency   | $f_{\sf SCLK}$          | 0    | _         | 5    | MHz  | _                         |  |
| 5.4.12 | Serial clock period  | $t_{SCLK(P)}$           | 200  | _         | _    | ns   | _                         |  |
| 5.4.13 | Serial clock high time   | $t_{\rm SCLK(H)}$       | 50   | _         | _    | ns   | _                         |  |
| 5.4.14 | Serial clock low time  | $t_{SCLK(L)}$           | 50   | _         | _    | ns   | _                         |  |
| 5.4.15 | Enable lead time (falling CS to rising SCLK)   | t <sub>SCLK(lead)</sub> | 250  | _         | _    | ns   | _                         |  |
| 5.4.16 | Enable lag time (falling SCLK to rising CS)  | $t_{\rm SCLK(lag)}$     | 250  | _         | _    | ns   | _                         |  |
| 5.4.17 | Transfer delay time (rising $\overline{\text{CS}}$ to falling $\overline{\text{CS}}$ ) | t <sub>CS(del)</sub>    | 250  | _         | _    | ns   | _                         |  |
| 5.4.18 | Data setup time (required time SI to falling SCLK)                                     | t <sub>SI(su)</sub>     | 20   | _         | -    | ns   | _                         |  |
| 5.4.19 | Data hold time (falling SCLK to SI)  | $t_{\rm SI(h)}$         | 20   | _         | _    | ns   | _                         |  |

<sup>1)</sup> Not subject to production test, specified by design.

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#### **Block Description and Electrical Characteristics**

Reset Value: xxxx<sub>H</sub>

Reset Value: xxxx<sub>H</sub>

#### 5.4.5 SPI Protocol

The SPI protocol of the SPIDER - TLE7232GS provides two types of registers. The control registers and the diagnosis registers. After power-on reset, all register bits set to default values.

SI

|    |     |    |    |    |    |      |   |   |   |   |    |    | Reset | Value | : xxxx <sub>H</sub> |
|----|-----|----|----|----|----|------|---|---|---|---|----|----|-------|-------|---------------------|
| 15 | 14  | 13 | 12 | 11 | 10 | 9    | 8 | 7 | 6 | 5 | 4  | 3  | 2     | 1     | 0                   |
| CI | CMD |    | 0  | 0  |    | ADDR | ı |   | 1 | ı | DA | TA | 1     | 1     | 1                   |

| Field | Bits  | Type | Description  |
|-------|-------|------|--|
| CMD   | 15:14 |      | <ul> <li>Command</li> <li>Diagnosis only: The requested data is shifted out at SO. This command does not change any register setting.</li> <li>Read register: The register content of the addressed register will be sent in the next frame.</li> <li>Reset registers: All registers are reset to their default values.</li> <li>Write register: The data of the SI word will be written to the addressed register.</li> </ul> |
| ADDR  | 10:8  |      | Address Pointer to register for read and write command   |
| DATA  | 7:0   |      | Data Data written to or read from register selected by address ADDR  |

# SO Standard Diagnosis

3 2 13 12 8 7 6 5 11 10 4 CH7 CH<sub>6</sub> CH<sub>5</sub> CH4 CH3 CH2 CH1 CH<sub>0</sub>

| Field     | Bits      | Type | Description                      |
|-----------|-----------|------|----------------------------------|
| CHn       | (2n+1):2n |      | Standard Diagnosis for Channel n |
| (n = 7-0) |           |      | 00 Short circuit to GND          |
|           |           |      | 01 Open load                     |
|           |           |      | 10 Overload, overtemperature     |
|           |           |      | 11 Normal operation              |

# SO Second Frame of Read Command

| 15 | 14 | 13 | 12 | 11 | 10 | 9    | 8 | 7 | 6 | 5 | 4  | 3  | 2 | 1  | 0 |
|----|----|----|----|----|----|------|---|---|---|---|----|----|---|----|---|
| 0  | 1  | 0  | 0  | 0  |    | ADDR |   |   | 1 | 1 | DA | TA | 1 | I. |   |

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#### **Block Description and Electrical Characteristics**

| Field | Bits | Type | Description  |
|-------|------|------|--|
| ADDR  | 10:8 |      | Address  |
|       |      |      | Pointer to register for read and write command                 |
| DATA  | 7:0  |      | Data   |
|       |      |      | Data written to or read from register selected by address ADDR |

Note: Reading a register needs two SPI frames. In the first frame the RD command is sent. In the second frame the output at SPI signal SO will contain the requested information. A new command can be executed in the second frame.

# 5.4.6 Register Overview

| Name | W/R | Addr             | 7    | 6    | 5    | 4    | 3    | 2    | 1    | 0    | Default <sup>1)</sup> |
|------|-----|------------------|------|------|------|------|------|------|------|------|-----------------------|
| IMCR | W/R | 001 <sub>B</sub> | MAP7 | MAP6 | MAP5 | MAP4 | MAP3 | MAP2 | MAP1 | MAP0 | 08 <sub>H</sub>       |
| BOCR | W/R | 010 <sub>B</sub> | BOL7 | BOL6 | BOL5 | BOL4 | BOL3 | BOL2 | BOL1 | BOL0 | 00 <sub>H</sub>       |
| OLCR | W/R | 011 <sub>B</sub> | OVL7 | OVL6 | OVL5 | OVL4 | OVL3 | OVL2 | OVL1 | OVL0 | 00 <sub>H</sub>       |
| OTCR | W/R | 100 <sub>B</sub> | OVT7 | OVT6 | OVT5 | OVT4 | OVT3 | OVT2 | OVT1 | OVT0 | 00 <sub>H</sub>       |
| SRCR | W/R | 101 <sub>B</sub> | SLE7 | SLE6 | SLE5 | SLE4 | SLE3 | SLE2 | SLE1 | SLE0 | 00 <sub>H</sub>       |
| STA  | R   | 110 <sub>B</sub> | OUT7 | OUT6 | OUT5 | OUT4 | OUT3 | OUT2 | OUT1 | OUT0 | 00 <sub>H</sub>       |
| CTL  | W/R | 111 <sub>B</sub> | OUT7 | OUT6 | OUT5 | OUT4 | OUT3 | OUT2 | OUT1 | OUT0 | 00 <sub>H</sub>       |

<sup>1)</sup> The default values are set after reset.

Due to the default value of the mapping register the IN3 is mapped to OUT3 after power up.

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**Application Circuit** 

# 6 Application Circuit

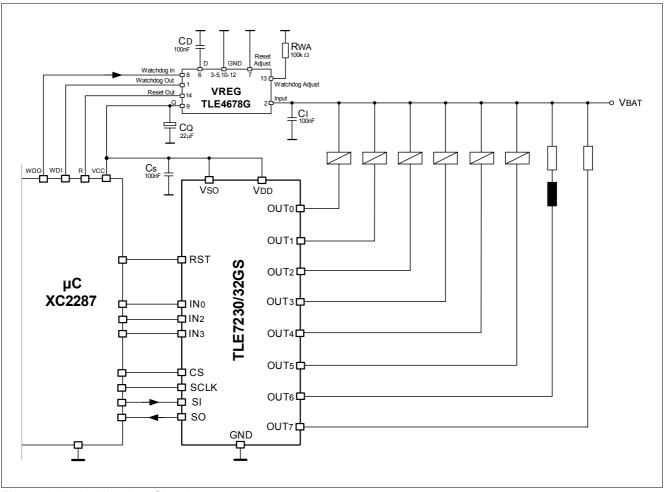


Figure 16 Application Circuit



**Package Outlines** 

# 7 Package Outlines

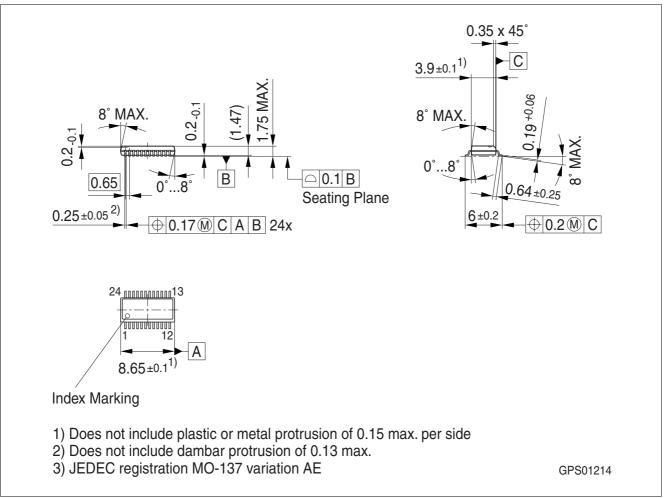


Figure 17 PG-SSOP-24-6 (Plastic Green Shrink Small Outline Package)

#### **Green Product (RoHS compliant)**

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).



**Revision History** 

# 8 Revision History

| Revision | Date       | Changes                                      |
|----------|------------|--|
| Rev. 1.0 | 2007-12-18 | layout completely updated (A4 page size)     |
|          |            | Application circuit added                    |
|          |            | Nominal load current inserted (page 14)      |
|          |            | Thermal Resistance section (page 15) updated |
|          |            |  |

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Edition 2007-12-18

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